

SECTION I
LIST OF MANUFACTURERS' QUALIFIED CAPABILITIES FOR EACH TECHNOLOGY

<p>MANUFACTURER INFORMATION: IMI, Inc. 140 Hilldale Avenue, Haverhill, MA, 01832</p>		<p>CAGE Code: 78259 Phone: 978-373-9190 Fax: 978-521-1846 EMail: sales@imipcb.com</p>
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CAPABILITIES BY TECHNOLOGY/ASSOCIATED SPECIFICATION

Specification: MIL-PRF-31032/1, MIL-PRF-31032/2
 Qualification Letters: VQ(VQE-17-031308)
 Composition: S - Homogenous thermosetting base material printed boards
 Rigid Base Material: GF: Woven E-Glass, Epoxy Resin, Flame Resistant
 Max. Panel Size: 16" x 18"
 Max. Number of Layers: 10
 Max. Board Thickness: .11"
 Min. Hole Size: .01" Drilled Plated-Through Hole Before Plating
 Aspect Ratio: 12.5:1 Through-Hole
 Min. Conductor Width/Space: .005"/.005"
 Hole Preparation: Permanganate Desmear
 Hole Wall Conductive Coating: Electroless Copper
 Copper Plating: Direct Current Plate
 Solder Resist: Liquid Photoimageable
 Finish System: HASL